Coiltronics FP1507R Family

High current power inductors

Applications

- Compatible with Picor® Cool-Power® ZVS Buck and Buck-Boost Regulator Families

Environmental Data

- Storage temperature range (component): -55°C to +125°C
- Operating temperature range: -55°C to +125°C (ambient plus self-temperature rise)
- Solder reflow temperature: J-STD-020D compliant

Description

- Magnetically shielded
- 15.1 x 8.5mm footprint surface mount package in a 6.7mm height
- Ferrite core material
- Halogen free, lead free, RoHS compliant

Pb HALOGEN HF FREE RoHS

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The Coiltronics brand of magnetics (formerly of the Bussmann Division of Cooper Industries) is now part of Eaton's Electrical Group, Electronics Division.

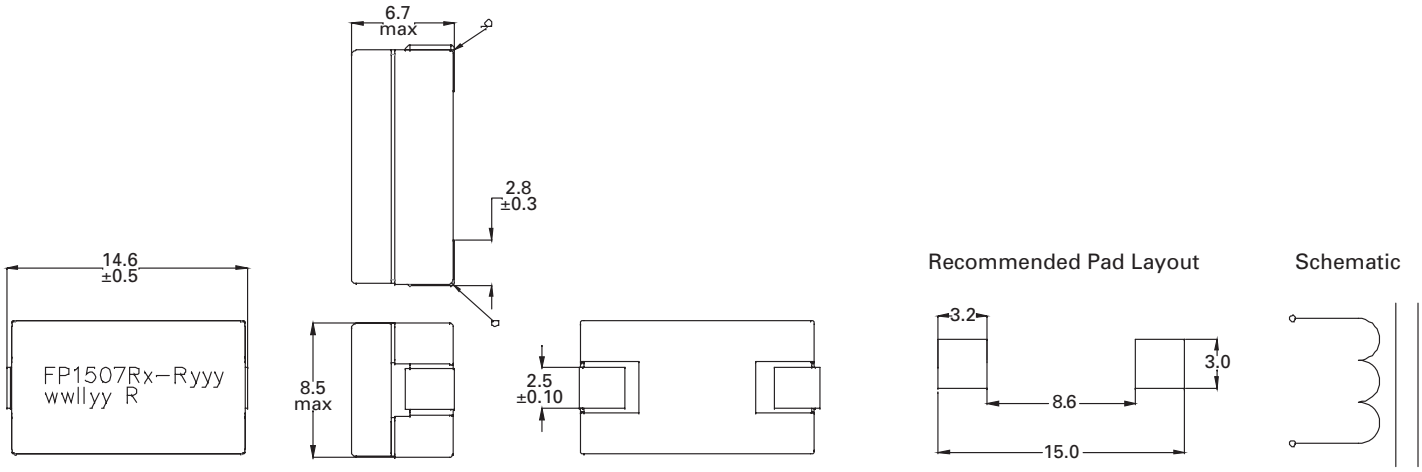
Coiltronics is now part of Eaton
Same great products plus even more.

Product Specifications

Part Number[5]	OCL[1] (nH) ±10%	FLL[2] (nH) minimum	I_{rms}[3] (amps)	I_{sat}[4] (amps)	DCR (mΩ) @ 20°C ±10%
FP1507R1-R185-R	185	163	45	40	0.52

1. Open Circuit Inductance (OCL) Test Parameters: 1.0MHz, 0.1Vrms, 0.0Adc, 25°C
2. Full Load Inductance (FLL) Test Parameters: 1.0MHz, 0.1Vrms, I_{sat}, 25°C
3. I_{rms}: DC current for an approximate temperature rise of 40°C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed 125°C under worst case operating conditions verified in the end application.
4. I_{sat}: Peak current for approximately 2% rolloff @ +25°C
5. Part Number Definition: FP1507Rx-Ryyy-R
   FP1507R = Product code and size
   x= DCR indicator
   Ryyy= yyy= inductance value in µH, R= decimal point
   -R suffix = RoHS compliant
   Note: Hipot: 250Vdc minimum for 2 seconds, 1.0mA, conductor to core

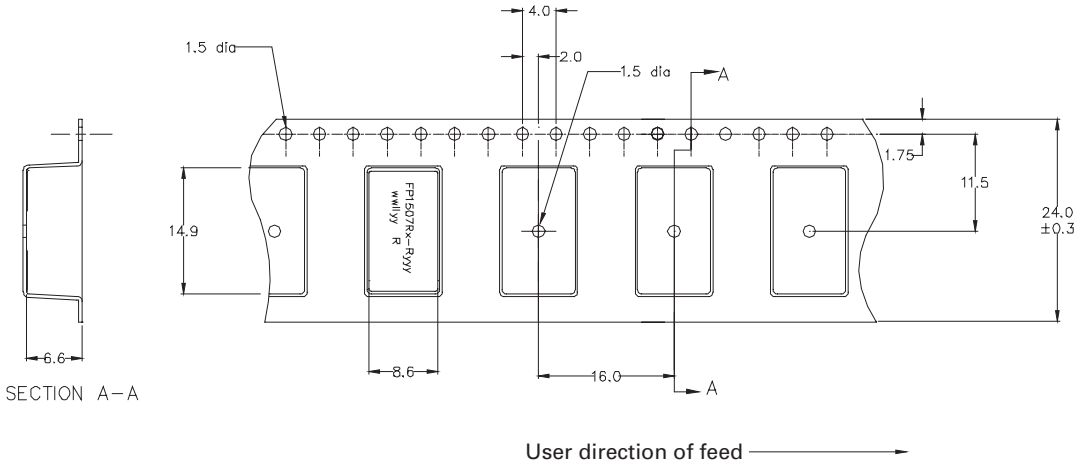
Dimensions (mm)



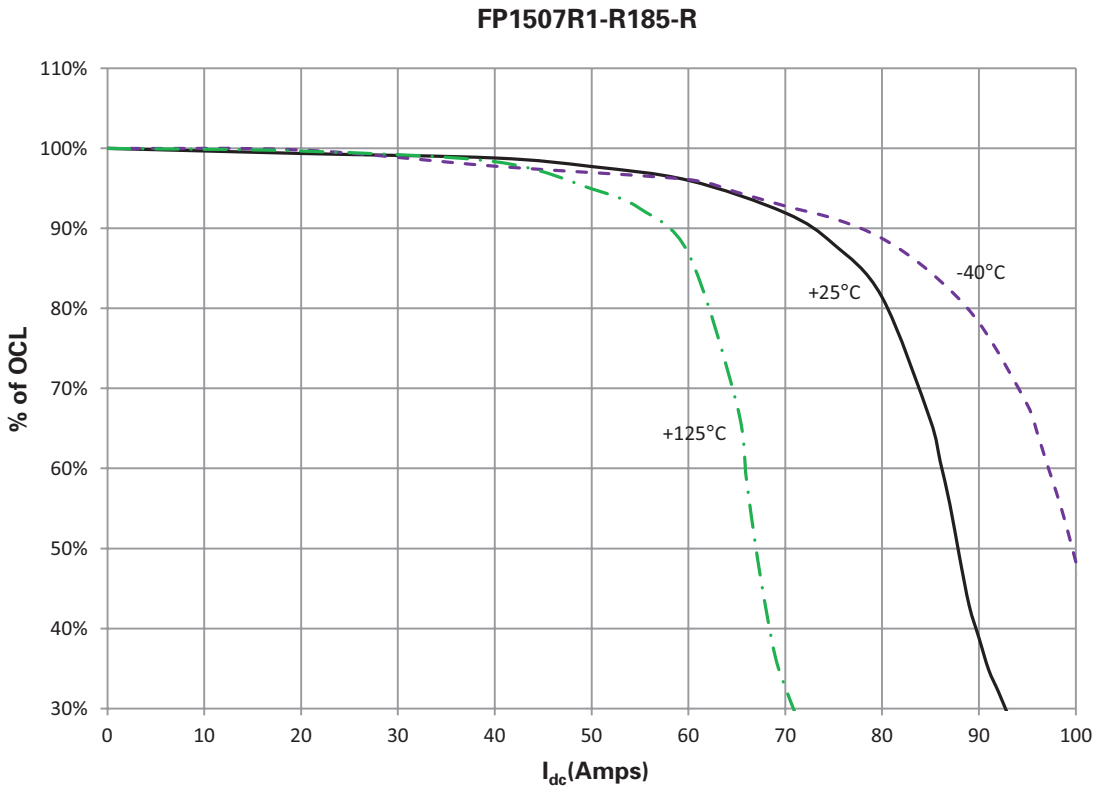
Part marking: FP1507Rx (x=DCR indicator), –Ryyy= (inductance value in uH, R=decimal point)
wwllyy= date code, R=revision level
Tolerances are ±0.25 unless stated otherwise
Soldering surfaces to be coplanar within 0.1 millimeters
DCR measured from point "a" to point "b"
Do not route traces or vias underneath the inductor.

Packaging information (mm)

Supplied in tape and reel packaging, 600 parts per 13" diameter reel



Inductance characteristics



Solder reflow profile

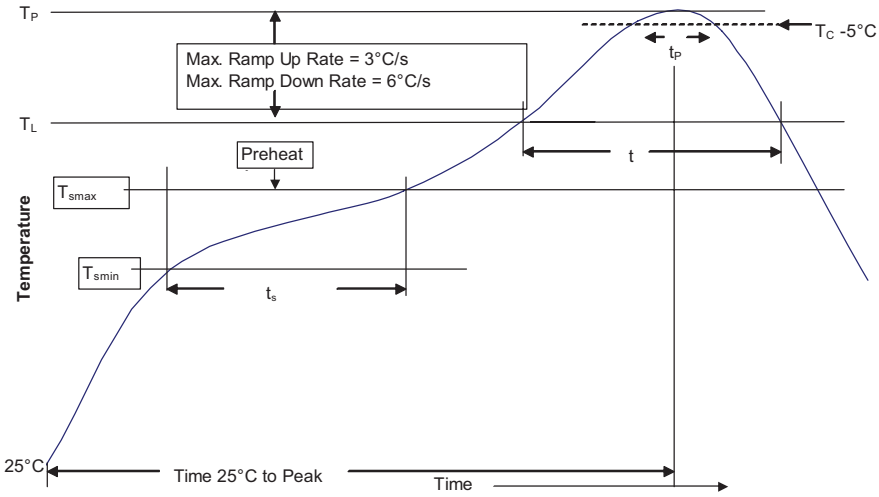


Table 1 - Standard SnPb Solder (T_C)

Package Thickness	Volume mm³ <350	Volume mm³ ≥350
<2.5mm)	235°C	220°C
≥2.5mm	220°C	220°C

Table 2 - Lead (Pb) Free Solder (T_C)

Package Thickness	Volume mm³ <350	Volume mm³ 350 - 2000	Volume mm³ >2000
<1.6mm	260°C	260°C	260°C
1.6 – 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

Reference JDEC J-STD-020D

Profile Feature		Standard SnPb Solder	Lead (Pb) Free Solder
Preheat and Soak	• Temperature min. (T_{smin})	100°C	150°C
	• Temperature max. (T_{smax})	150°C	200°C
	• Time (T_{smin} to T_{smax}) (t_s)	60-120 Seconds	60-120 Seconds
Average ramp up rate T_{smax} to T_p		3°C/ Second Max.	3°C/ Second Max.
Liquidous temperature (T_L) Time at liquidous (t_L)		183°C 60-150 Seconds	217°C 60-150 Seconds
Peak package body temperature (T_P)*		Table 1	Table 2
Time (t_p)** within 5 °C of the specified classification temperature (T_C)		20 Seconds**	30 Seconds**
Average ramp-down rate (T_p to T_{smax})		6°C/ Second Max.	6°C/ Second Max.
Time 25°C to Peak Temperature		6 Minutes Max.	8 Minutes Max.

* Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.
** Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.